

### Features

- Advanced Trench Process Technology
- Low Threshold Voltage
- Fast Switching Speed
- Epoxy Meets UL 94 V-0 Flammability Rating
- Moisture Sensitivity Level 1
- Halogen Free. "Green" Device (Note 1)
- Lead Free Finish/RoHS Compliant ("P" Suffix Designates RoHS Compliant. See Ordering Information)

### Maximum Ratings

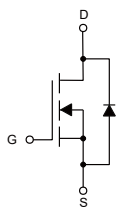
- Operating Junction Temperature Range: -55°C to +150°C
- Storage Temperature: -55°C to +150°C
- Thermal Resistance: 115°C/W Junction to Ambient<sup>(Note2)</sup>

Parameter	Symbol	Rating	Unit
Drain-Source Voltage	V <sub>DS</sub>	60	V
Gate-Source Voltage	V <sub>GS</sub>	±20	V
Drain Current-Continuous	I <sub>D</sub>	TA=25°C	0.34
		TA=100°C	0.22
Pulsed Drain Current	I <sub>DM</sub>	2	A
Power Dissipation	P <sub>D</sub>	1.08	W

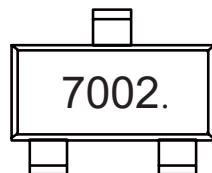
Note:

1. Halogen free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.
2. The value of R<sub>θJA</sub> is measured with the device mounted on 1in<sup>2</sup> FR-4 board with 2oz. Copper, in a still air environment with T<sub>A</sub>=25°C

### Internal Structure and Marking Code

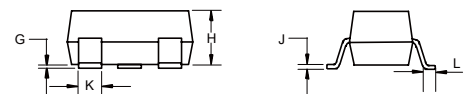
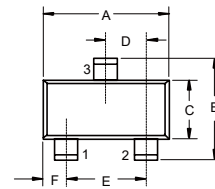


1. GATE
2. SOURCE
3. DRAIN



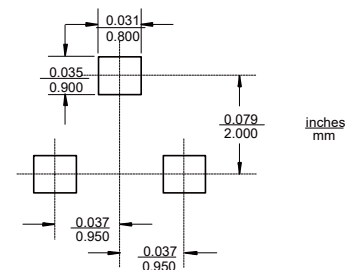
## N-Channel MOSFET

### SOT-23



DIM	INCHES		MM		NOTE
	MIN	MAX	MIN	MAX	
A	0.110	0.120	2.80	3.04	
B	0.083	0.104	2.10	2.64	
C	0.047	0.055	1.20	1.40	
D	0.034	0.041	0.85	1.05	
E	0.067	0.083	1.70	2.10	
F	0.018	0.024	0.45	0.60	
G	0.0004	0.006	0.01	0.15	
H	0.035	0.043	0.90	1.10	
J	0.003	0.007	0.08	0.18	
K	0.012	0.020	0.30	0.51	
L	0.007	0.020	0.20	0.50	

### Suggested Solder Pad Layout



**ELECTRICAL CHARACTERISTICS (Ta=25°C unless otherwise specified)**

Parameter	Symbol	Test conditions	Min	Typ	Max	Unit
<b>Static Characteristics</b>						
Drain-Source Breakdown Voltage	$V_{(BR)DSS}$	$V_{GS}=0V, I_D=250\mu A$	60			V
Gate-Threshold Voltage	$V_{GS(th)}$	$V_{DS}=V_{GS}, I_D=250\mu A$	1.0	1.5	2.5	V
Gate-Body Leakage	$I_{GSS}$	$V_{DS}=0V, V_{GS}=\pm 20V$			$\pm 10$	nA
Zero Gate Voltage Drain Current	$I_{DSS}$	$V_{DS}=60V, V_{GS}=0V$			80	nA
Drain-Source On-Resistance	$R_{DS(on)}$	$V_{GS}=10V, I_D=300mA$		1.2	2.5	$\Omega$
		$V_{GS}=4.5V, I_D=200mA$		1.3	3.0	
Forward Transconductance	$g_{fs}$	$V_{DS}=10V, I_D=200mA$	80			ms
Diode Forward Voltage	$V_{SD}$	$V_{GS}=0V, I_S=300mA$			1.2	V
Diode Forward Current	$I_S$				340	mA
<b>Static Characteristics</b>						
Input Capacitance	$C_{iss}$	$V_{DS}=25V, V_{GS}=0V, f=1MHz$		35		pF
Output Capacitance	$C_{oss}$			5		
Reverse Transfer Capacitance	$C_{rss}$			4		
Reverse Recovery Charge	$Q_{rr}$	$I_F=0.34A, di/dt=100A/us$		8.5		nC
Reverse Recovery Time	$t_{rr}$			8		ns
Total Gate Charge	$Q_g$	$V_{DS}=30V, V_{GS}=10V, I_D=0.34A$		1.7		nC
Gate-Source Charge	$Q_{gs}$			0.5		
Gate-Drain Charge	$Q_{gd}$			0.3		
Turn-on Delay Time	$t_{d(on)}$	$V_{DD}=30V, V_{GS}=10V, I_D=340mA, R_{GEN}=6\Omega$		0.9		ns
Turn-on Rise Time	$t_r$			15		
Turn-off Delay Time	$t_{d(off)}$			4.5		
Turn-off fall Time	$t_f$			33		

Curve Characteristics

Fig. 1 - Typical Output Characteristics

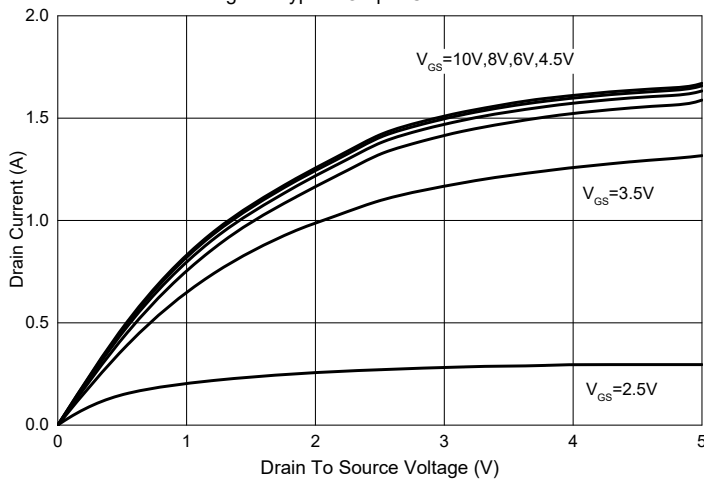


Fig. 2 - Transfer Characteristics

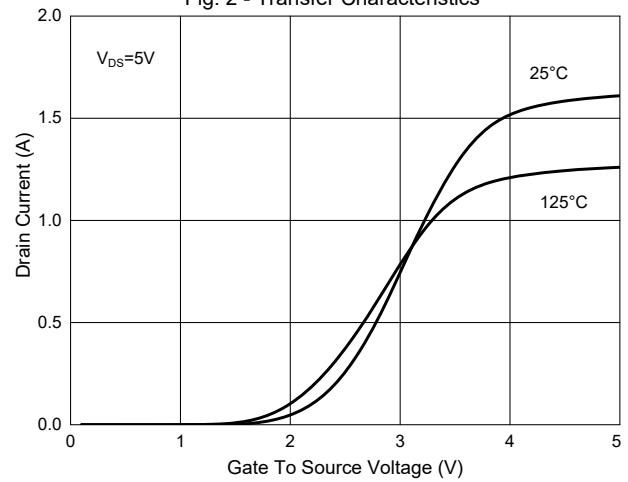


Fig. 3 - Normalized On Resistance Characteristics

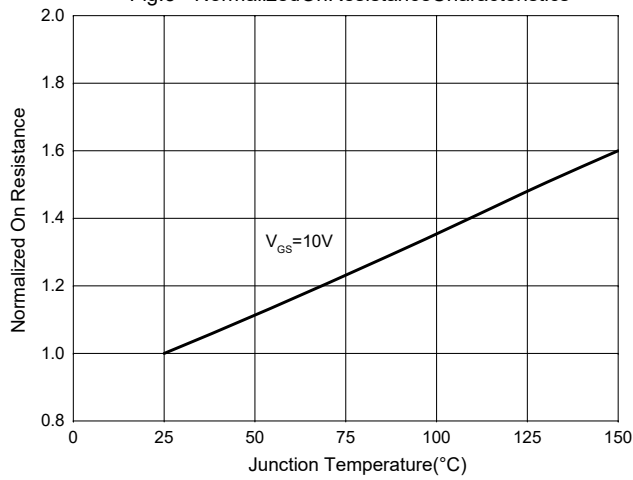


Fig. 4 -  $R_{DS(ON)} - I_D$

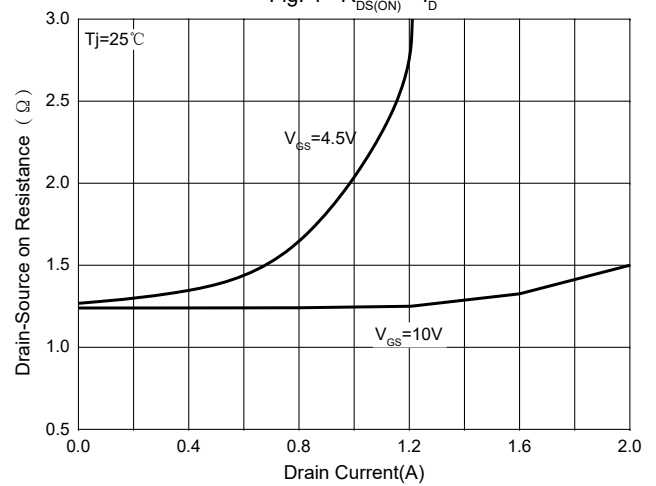


Fig. 5 - Gate Charge

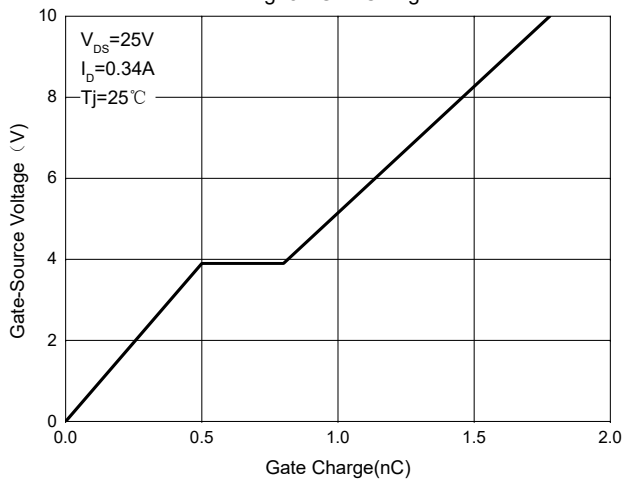
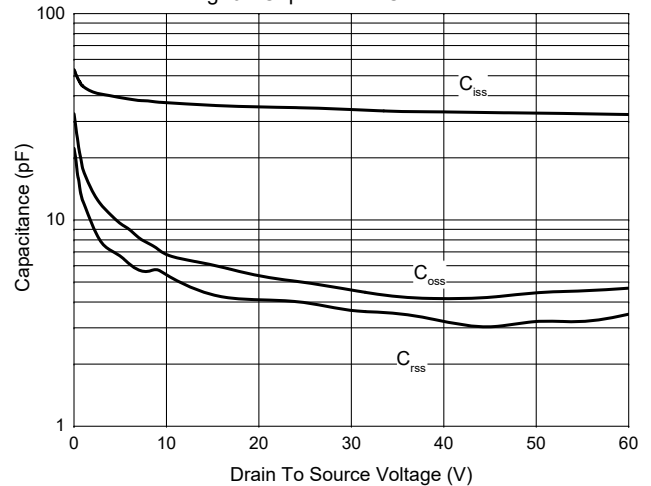


Fig. 6 - Capacitance Characteristics



Curve Characteristics

Fig. 7 -  $I_s - V_{SD}$

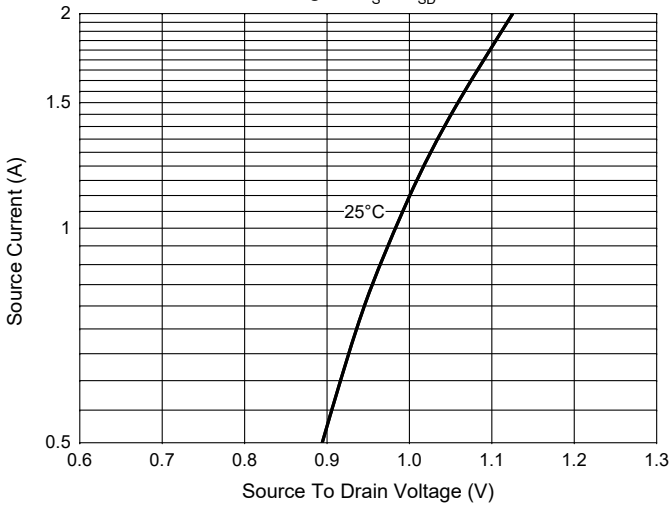


Fig. 8 - Safe Operation Area

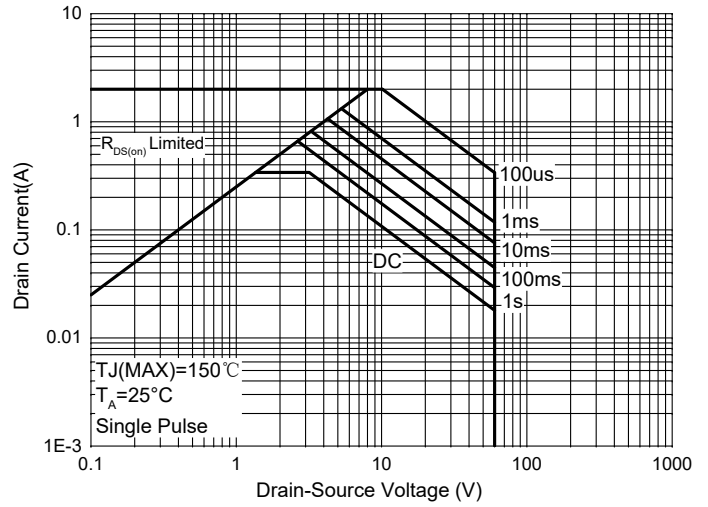
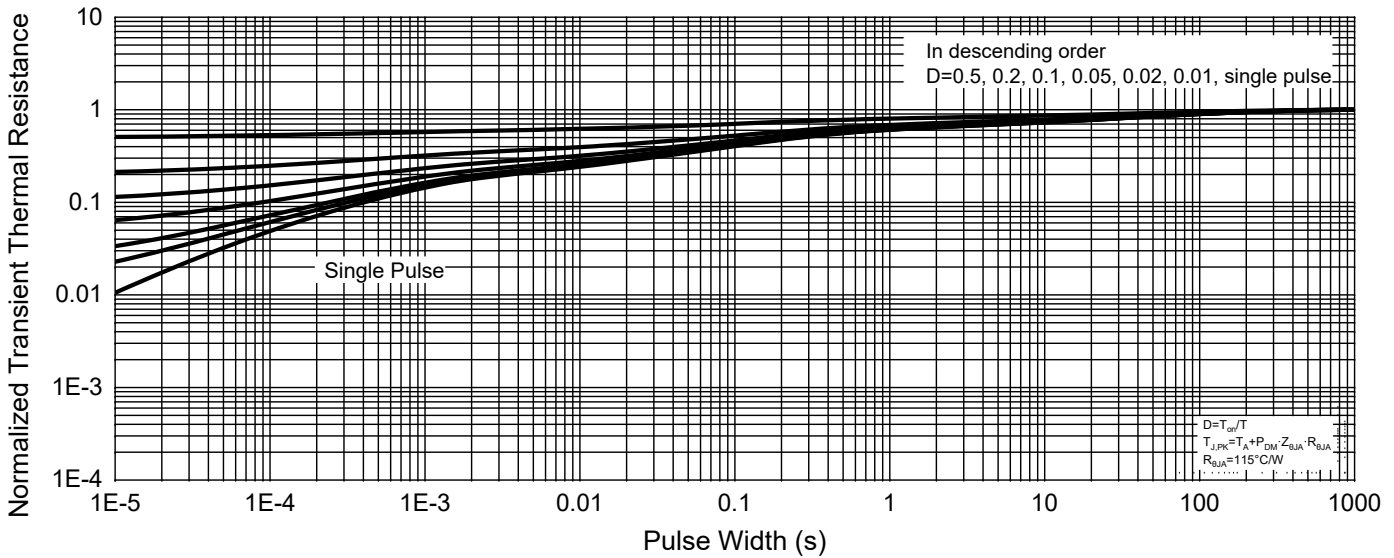


Fig. 9 - Normalized Transient Thermal Impedance



## Ordering Information

Device	Packing
Part Number-TP	Tape&Reel: 3Kpcs/Reel
Part Number-13P	Tape&Reel: 10Kpcs/Reel

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